502834374 06/03/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2880970

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tai-Yu Chen	05/28/2014
Wen-Tsan Hsieh	05/28/2014
Chi-Wei Yang	05/28/2014

RECEIVING PARTY DATA

Name:	MEDIATEK INC.
Street Address:	No. 1, Dusing Rd. 1st, Science-Based Industrial Park
City:	Hsin-Chu
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14294170

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NAME OF SUBMITTER:	SHELLEY KUO
SIGNATURE:	/SHELLEY KUO/
DATE SIGNED:	06/03/2014

Total Attachments: 2 source=1967610#page1.tif source=1967610#page2.tif

PATENT 502834374 REEL: 033012 FRAME: 0540

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

110010110	R(S) (Inventors):		
Name:	Tai-Yu Chen	Nationality:	TW
Name:	Wen-Tsan Hsieh	Nationality:	TW
Name:	Chi-Wei Yang	Nationality:	TW
Hereby sells,	assigns and transfers to	•	
ASSIGNEE(•		
Name:	MEDIATEK INC.		
Address	: No. 1, Dusing Rd. 1st, Sci	ence-Based Industrial Park, Hsin-Cl	hu 300, Taiwan, R.O.C.
and the succe any and all im	ssors and assignees of the A	SSIGNEE the entire right, title, an	7,700
Which is fou			
(a) <u>+</u>	U.S. patent application exec	ruted on even date	
		cuted on	
		issued	
	patent no.	IDDAAA	

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NPO#MTK-P1801-USA:0 CUST#MTKI-13-180US

F#NPO-P0002E-US1 DSC0-103U003124 and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this 214.05.26 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)	Signature of INVENTOR	
<u>Tai-Yu Chen</u>	Tas-yn Chen.	
Wen-Tsan Hsieh	Wan-Tran Staits	
Chi-Wei Yang	Chilina Vana	

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F#NPO-P0002E-US1 DSC0-103U003124

RECORDED: 06/03/2014

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